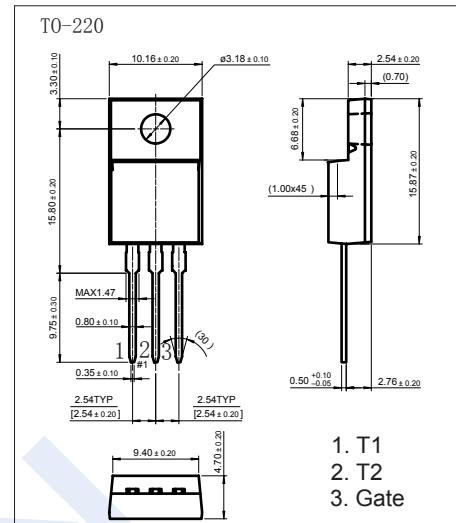
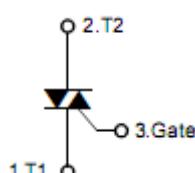


## TRIACS Thyristor

## BTA16-600

## ■ Features

- Repetitive peak off-state voltages :600V
- RMS on-state current :16A



## ■ Absolute Maximum Ratings Ta = 25°C

Parameter	Symbol	Rating	Unit
Peak Repetitive Forward and Reverse Blocking Voltages	V <sub>DRM</sub> V <sub>RRM</sub>	600	V
RMS on-state Current	I <sub>T</sub> (RMS)	16	A
Non-Repetitive Peak on-state Current @ 50Hz, t <sub>p</sub> =20ms	I <sub>TSM</sub>	160	
junction Temperature	T <sub>J</sub>	125	°C
Storage Temperature range	T <sub>stg</sub>	-40 to 150	

## ■ Electrical Characteristics (Ta = 25°C, unless otherwise noted.)

Parameter	Symbol	Test Conditions	Min	Typ.	Max	Unit
Repetitive Peak off-state Voltages	V <sub>DRM</sub> V <sub>RRM</sub>	I <sub>D</sub> =I <sub>R</sub> =10uA	600			V
Off-state Leakage Current	I <sub>D</sub> ,I <sub>R</sub>	V <sub>DRM</sub> =V <sub>RRM</sub> =V <sub>D</sub>			0.1	mA
On-state Voltage	V <sub>TM</sub>	I <sub>T</sub> =22.5A			1.55	V
Gate Trigger Voltage	V <sub>GT</sub>	V <sub>D</sub> =12V, R <sub>L</sub> =100Ω	T <sub>2+</sub> ,G <sub>+</sub>		1	
			T <sub>2+</sub> ,G <sub>-</sub>		1	
			T <sub>2-</sub> ,G <sub>-</sub>		1	
Gate Trigger Current	I <sub>GT</sub>	V <sub>D</sub> =12V, R <sub>L</sub> =100Ω	T <sub>2+</sub> ,G <sub>+</sub>		50	mA
			T <sub>2+</sub> ,G <sub>-</sub>		50	
			T <sub>2-</sub> ,G <sub>-</sub>		50	
Holding Current	I <sub>H</sub>	I <sub>GT</sub> =500mA			50	V/us
Critical rate of rise of off state voltage	dV/dt	V <sub>DM</sub> =67%V <sub>DRM</sub> Gate open T <sub>j</sub> =110°C	500			
Critical rate of rise of commuting voltage	(dV/dt) <sub>c</sub>		10			
Trigger voltage	V <sub>GD</sub>	V <sub>D</sub> =1/2 V <sub>DRM</sub>	0.2			V

## TRIACS Thyristor

### BTA16-600

#### ■ Typical Characteristics

Figure 1: Maximum power dissipation versus RMS on-state current (full cycle)

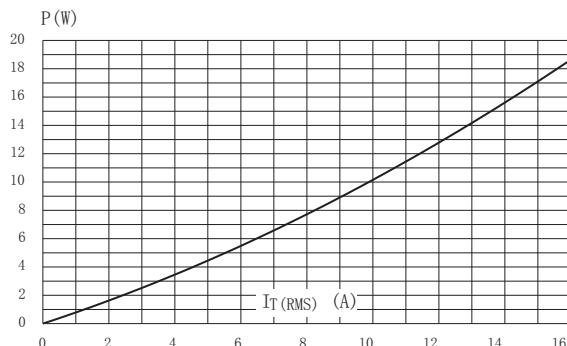


Figure 3: RMS on-state current versus ambient temperature (printed circuit board FR4, copper thickness: 35 $\mu$ m) (full cycle)

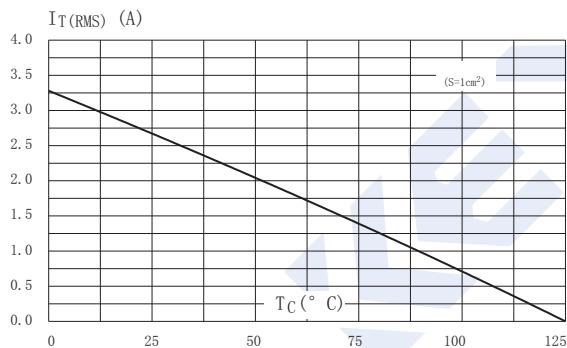


Figure 5: On-state characteristics (maximum values)

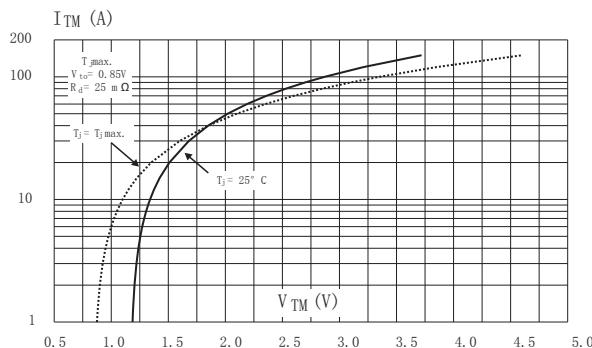


Figure 2: RMS on-state current versus case temperature (full cycle)

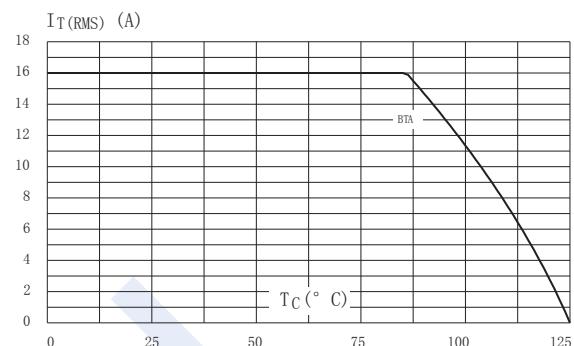


Figure 4: Relative variation of thermal impedance versus pulse duration

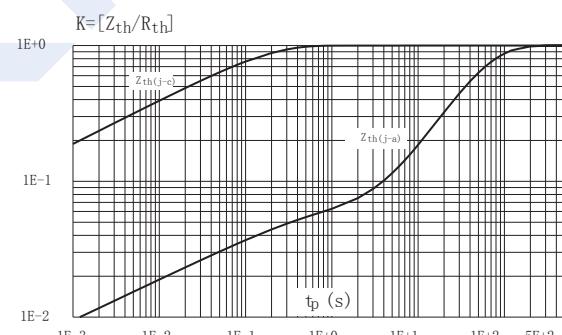
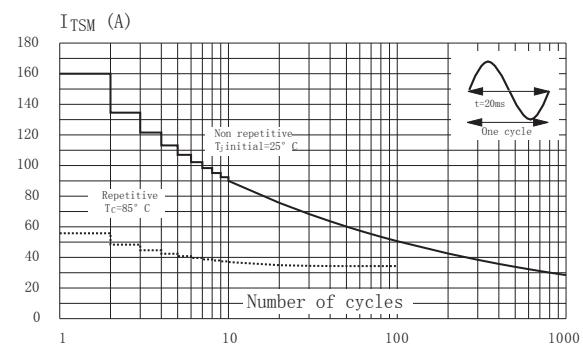


Figure 6: Surge peak on-state current versus number of cycles



## TRIACS Thyristor

### BTA16-600

#### ■ Typical Characteristics

Figure 7: Non-repetitive surge peak on-state current for a sinusoidal pulse with width  $t_p < 10$  ms and corresponding value of  $I^2t$

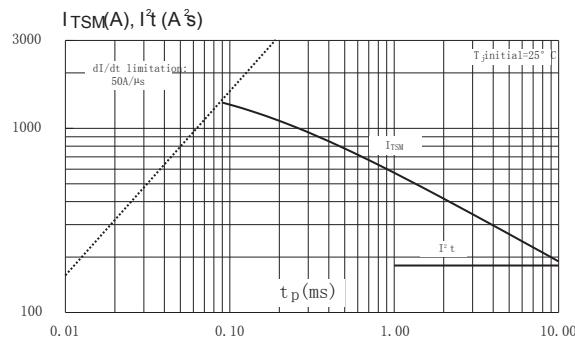


Figure 9: Relative variation of critical rate of decrease of main current versus  $(dV/dt)_c$  (typical values) (Snubberless & Logic level types)

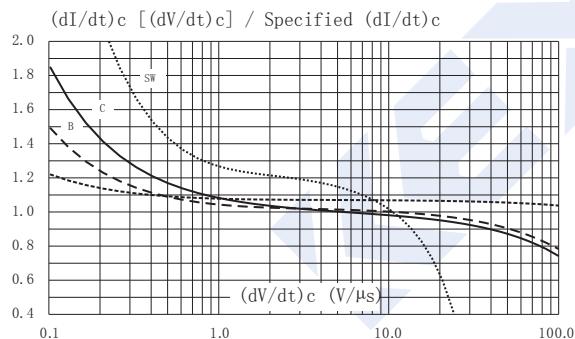


Figure 11: Thermal resistance junction to ambient versus copper surface under tab (printed circuit board FR4, copper thickness: 35 μm)

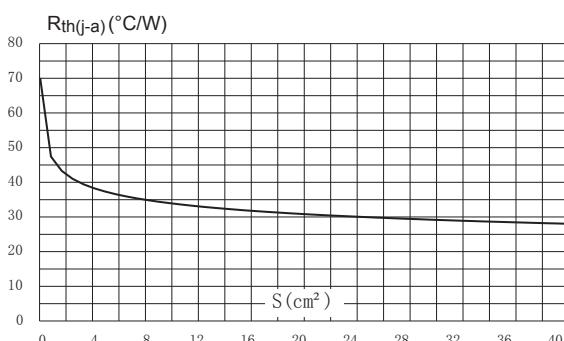


Figure 8: Relative variation of gate trigger current, holding current and latching current versus junction temperature (typical values)

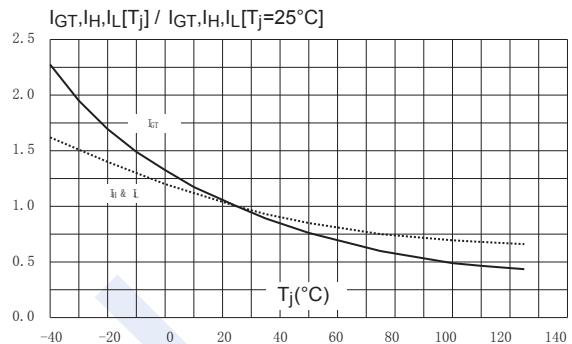


Figure 10: Relative variation of critical rate of decrease of main current versus  $(dV/dt)_c$  (typical values) (Standard types)

